

Certificate

Standard **IATF 16949:2016**
(1st edition, 2016-10-01)

Certificate Registr. No. **01 111 096703**
IATF Certificate No. **0489167**

Certificate Holder: **PacTech Asia Sdn. Bhd.**
No. 14, Medan Bayan Lepas Technoplex,
Phase 4, Bayan Lepas Industrial Zone,
11900 Bayan Lepas, Pulau Pinang
Malaysia

IATF USI: **3GERWA**

Scope: **Manufacturing of Wafer Bumping and Back End Products**
Excluding Product Design

Proof has been furnished by means of an audit that the requirements of IATF 16949:2016 are met.

Validity: **The certificate is valid from 2023-11-22 until 2026-11-21.**

Release date: **2023-11-22**



TÜV Rheinland Cert GmbH
Am Grauen Stein · 51105 Köln
Germany - NRW



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